Electronic Patent Application Fee Transmittal							
Application Number:	105	10523777					
Filing Date:	08-	08-Jul-2005					
Title of Invention:	METHOD AND SYSTEM FOR DYNAMIC MODELING AND RECIPE OPTIMIZATION OF SEMICONDUCTOR ETCH PROCESSES						
First Named Inventor/Applicant Name:	Kun Li						
Filer:	Joseph R. Jordan/Geena Licata						
Attorney Docket Number:	VOY-007US						
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